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January 2001

### FDC640P

FAIRCHILD

### P-Channel 2.5V PowerTrench<sup>®</sup> Specified MOSFET

### **General Description**

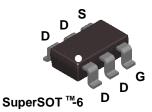
This P-Channel 2.5V specified MOSFET uses a rugged gate version of Fairchild's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

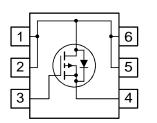
### Applications

- Battery management
- Load switch
- Battery protection

### Features

- -4.5 A, -20 V  $R_{DS(ON)} = 0.053 \ \Omega \ @ V_{GS} = -4.5 \ V$  $R_{DS(ON)} = 0.080 \ \Omega \ @ V_{GS} = -2.5 \ V$
- Rugged gate rating (±12V)
- Fast switching speed
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$





### Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		-20	V
V <sub>GSS</sub>	Gate-Source Voltage		±12	V
I <sub>D</sub>	Drain Current – Continuous	(Note 1a)	-4.5	A
	– Pulsed		-20	
PD	Maximum Power Dissipation	(Note 1a)	1.6	W
		(Note 1b)	0.8	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

### **Package Marking and Ordering Information**

Device Marking	Device	Reel Size	Tape width	Quantity
.640	FDC640P	7"	8mm	3000 units
			•	

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FDC640P

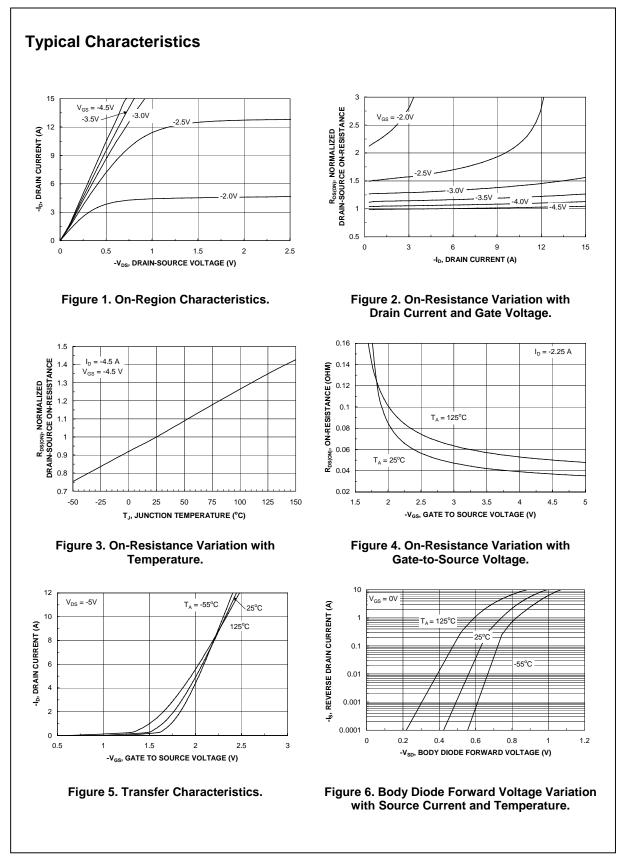
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
- Off Char	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-20			V
$\Delta BV_{DSS}$ $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to 25°C		-14		mV/°C
	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$ , $V_{GS} = 0 V$			-1	μA
I <sub>GSSF</sub>	Gate–Body Leakage, Forward	$V_{GS} = 12 V$ , $V_{DS} = 0 V$			100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -12 V$ , $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)				L	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.6	-1.0	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		3		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS}=-4.5 \; V,  I_{D}=-4.5 \; A \\ V_{GS}=-2.5 \; V,  I_{D}=-3.6 \; A \\ V_{GS}=-4.5 \; V, \; I_{D}=-4.5 A, \\ T_{J}=125^{\circ}C \end{array} $		0.039 0.062 0.053	0.053 0.080 0.077	Ω
D(on)	On–State Drain Current	$V_{\text{GS}} = -4.5 \text{ V}, \qquad V_{\text{DS}} = -5 \text{ V}$	-20			Α
<b>g</b> fs	Forward Transconductance	$V_{\text{DS}} = -5 \text{ V}, \qquad I_{\text{D}} = -4.5 \text{ A}$		16		S
Dynamic	c Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -10 V$ , $V_{GS} = 0 V$ ,		890		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		244		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			123		pF
Switchir	g Characteristics (Note 2)			•		
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = -10 V$ , $I_D = -1 A$ ,		12	22	ns
tr	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		9	18	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			24	38	ns
t <sub>f</sub>	Turn–Off Fall Time			13	23	ns
Qg	Total Gate Charge	$V_{DS} = -10 V$ , $I_D = -4.5 A$ ,		9	13	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = -4.5 V$		2		nC
Q <sub>gd</sub>	Gate-Drain Charge			3		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source				-1.3	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_S = -1.3 A$ (Note 2)		-0.7	-1.2	V

1.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.

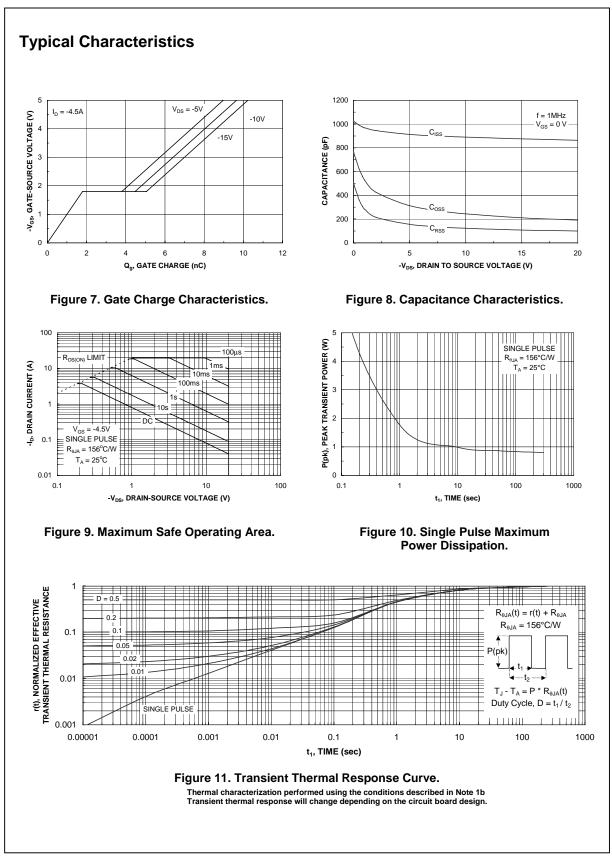
a. 78°C/W when mounted on a 1in<sup>2</sup> pad of 2oz copper on FR-4 board.

b. 156°C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width  $\leq 300~\mu s,$  Duty Cycle  $\leq 2.0\%$ 



# FDC640P



# FDC640P

FDC640P Rev E(W)

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